

# MU1017V LDMOS TRANSISTOR

Document Number: MU1017V  
Preliminary Datasheet V1.0

## HF-1GHz, 170W, 50V RF LDMOS FETs

### Description

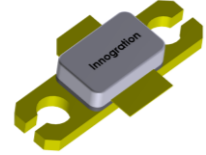
The MU1017V is a 1700-watt, highly rugged, unmatched LDMOS FET, designed for wide-band commercial and industrial applications at frequencies HF to 1GHz.

- Typical Performance (On Innogration narrow band fixture with device soldered):

Pulsed CW , VDS=50V, VGS=3.3V, Idq=120mA

Freq(MHz)	Pin(dBm)	Pout(W)	Gain(dB)	EFF(%)
700	31.5	180	21	71%

### MU1017V



### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### Suitable Applications

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)
- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)
- 100kHz - 1000MHz (ISM, instrumentation)

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain--Source Voltage	$V_{DS}$	110	Vdc
Gate--Source Voltage	$V_{GS}$	-10 to +10	Vdc
Operating Voltage	$V_{DD}$	+55	Vdc
Storage Temperature Range	$T_{stg}$	-65 to +150	°C
Case Operating Temperature	$T_c$	+150	°C
Operating Junction Temperature	$T_j$	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case $T_c=85^{\circ}\text{C}$ , $T_j=200^{\circ}\text{C}$ , DC test	$R_{\theta JC}$	0.61	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

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**Table 4. Electrical Characteristics** (TA = 25 °C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>DC Characteristics</b>					
Drain-Source Voltage V <sub>GS</sub> =0, I <sub>DS</sub> =1.0mA	V <sub>(BR)DSS</sub>		110		V
Zero Gate Voltage Drain Leakage Current (V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0 V)	I <sub>DSS</sub>	—	—	1	μA
Gate--Source Leakage Current (V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 0 V)	I <sub>GSS</sub>	—	—	1	μA
Gate Threshold Voltage (V <sub>DS</sub> = 50V, I <sub>D</sub> = 600 μA)	V <sub>GS(th)</sub>	—	2.73	—	V
Gate Quiescent Voltage (V <sub>DD</sub> = 50 V, I <sub>D</sub> = 200 mA, Measured in Functional Test)	V <sub>GS(Q)</sub>	—	3.3	—	V
Common Source Input Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =50 V, f = 1 MHz)	C <sub>ISS</sub>		130		pF
Common Source Output Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =50 V, f = 1 MHz)	C <sub>OSS</sub>		50		pF
Common Source Feedback Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =50 V, f = 1 MHz)	C <sub>RSS</sub>		1.3		pF

**Functional Tests** (In Demo Test Fixture, 50 ohm system) V<sub>DD</sub> = 50 Vdc, I<sub>DQ</sub> = 100mA, f = 700 MHz, Pulsed CW Signal Measurements,

Pin=31.5dBm

Power Gain@Pout	G <sub>p</sub>	—	21	—	dB
Output Power	P <sub>out</sub>	170	180		W
Drain Efficiency@Pout	η <sub>D</sub>	—	70	—	%
Input Return Loss	IRL	—	-7	—	dB

## TYPICAL CHARACTERISTICS

Figure 1: Pulsed CW Gain and Power Efficiency as a Function of Pout at 700MHz

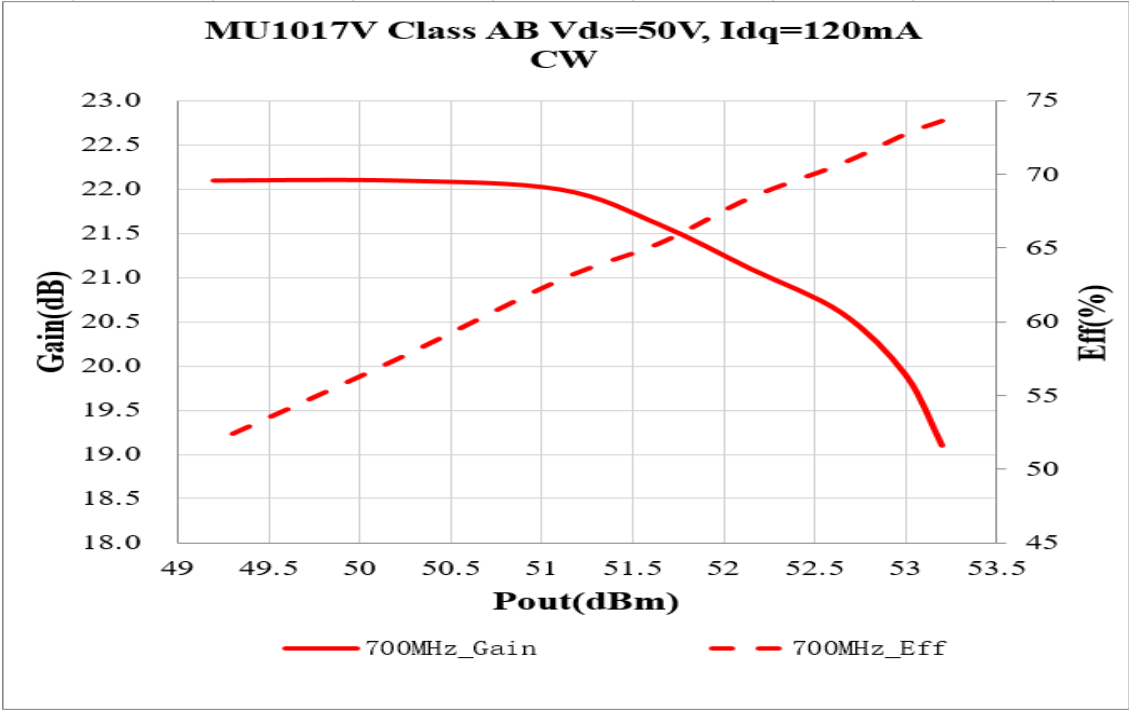
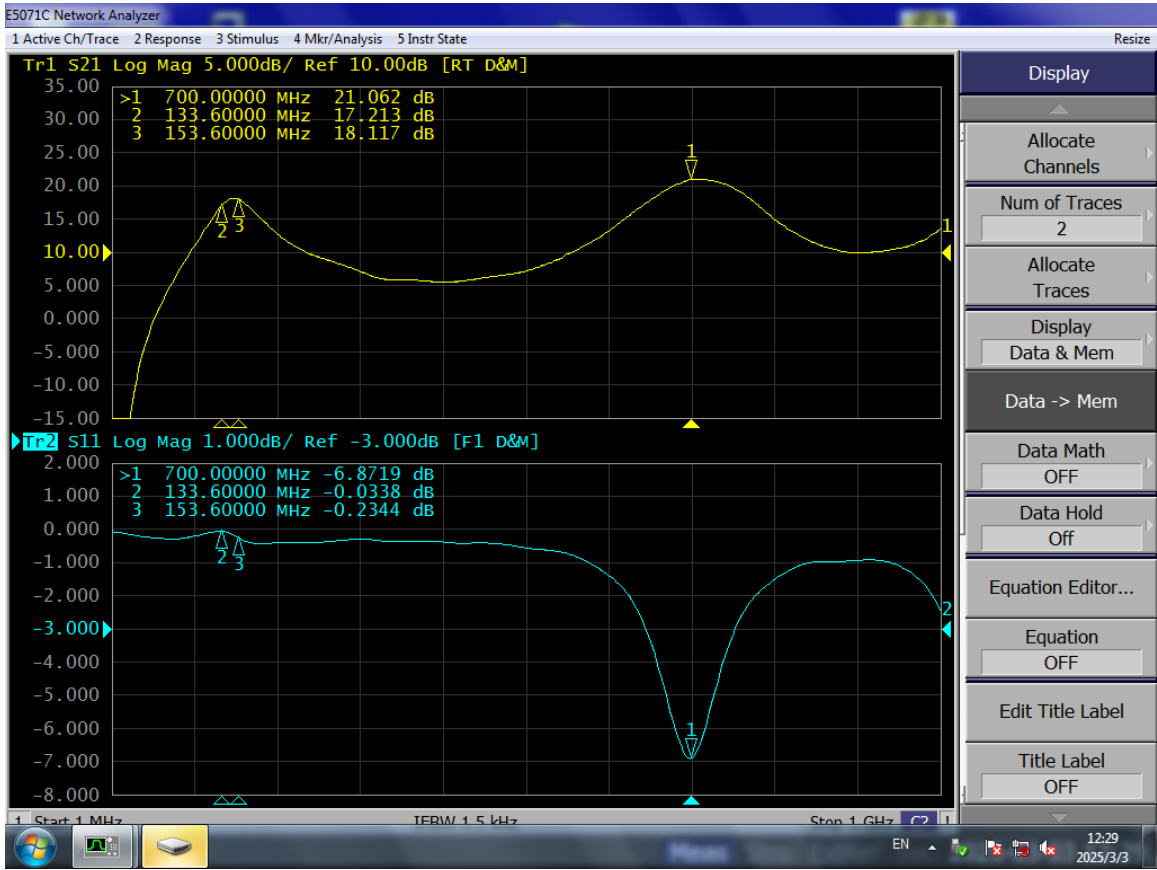


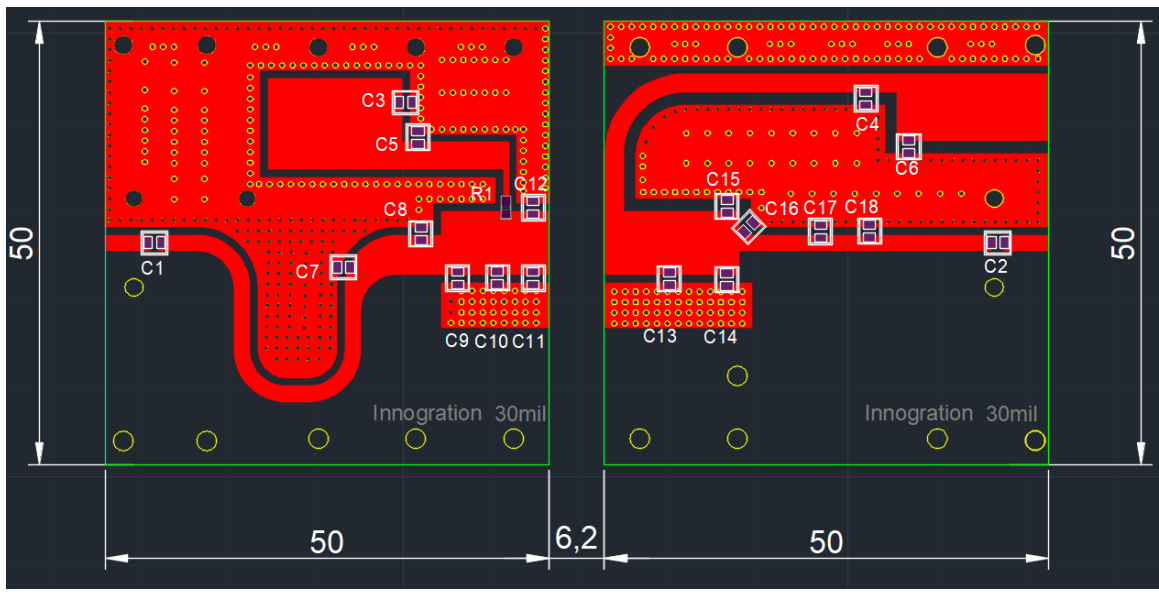
Figure 2: Network analyzer output S11/221



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Reference Circuit of Test Fixture Assembly Diagram  
700MHz Class AB (Layout file upon request,)



Test Circuit Component Designations and Values

Component	Description		Suggestion
C3,C6	10uF	1210	/
R1	22 $\Omega$	0805	/
C1,C2	20pF	MQ301111	
C2,C4,C5	100pF	MQ301111	
C7,C17	8.2pF	MQ301111	
C8,C14,C16	10pF	MQ301111	
C9,C10	12pF	MQ301111	
C11,C12	18pF	MQ301111	
C13	15pF	MQ301111	
C15	6.2pF	MQ301111	
C18	2.0pF	MQ301111	

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## Package Outline

Flanged ceramic package; 2 leads

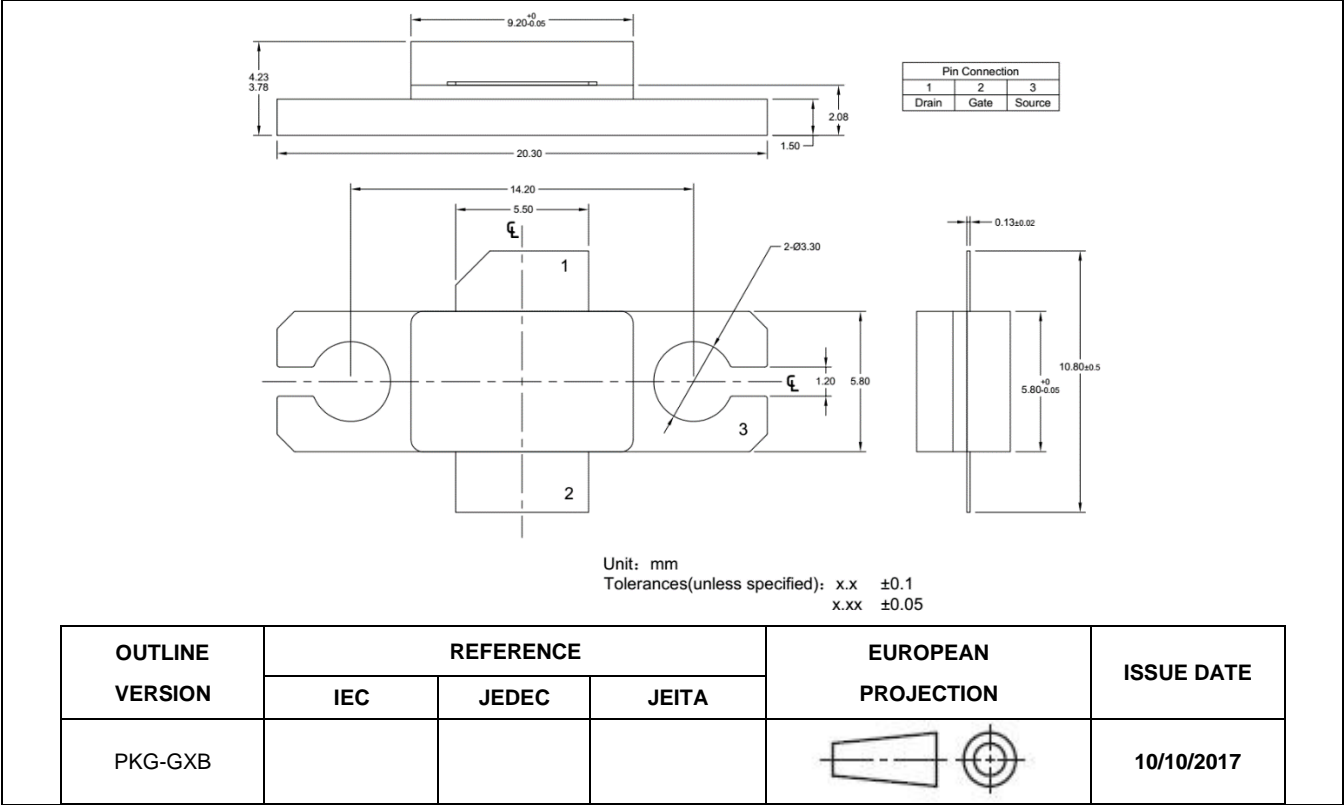


Figure 1. Package Outline PKG-G2E

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## Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2025/3/5	V1.0	Preliminary Datasheet Creation

Application data based on SYX-25-09

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